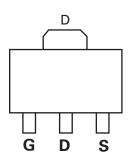


COMPLIANT

## AP2310GG-HF-VB Datasheet

## N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY								
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)					
<u> </u>	0.076 at V <sub>GS</sub> = 10 V	5.5	29 nC					
60	0.088 at V <sub>GS</sub> = 4.5 V	4.5	29110					

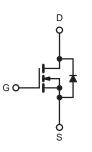


#### **FEATURES**

- Halogen-free
- Trench Power MOSFET

#### **APPLICATIONS**

· Load Switches for Portable Devices



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	$IGS I_A = 25 C,$	unless other	wise noted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	60	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		5.5 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		4 <sup>a</sup>		
	T <sub>A</sub> = 25 °C		4.7 <sup>a, b, c</sup>		
	T <sub>A</sub> = 70 °C		4 <sup>a, b, c</sup>	A	
Pulsed Drain Current	·	I <sub>DM</sub>	20		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	5.2		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	5.1 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		5.3		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	4	w	
	T <sub>A</sub> = 25 °C		2.5 <sup>b, c</sup>	v v	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperatur	e Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temper	ature) <sup>e, f</sup>		260		

#### THERMAL RESISTANCE BATINGS

Parameter	Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>a, c, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	40	50	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	15	20	0/11			

Notes:

a. Package limited, T<sub>C</sub> = 25 °C.
b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 95 °C/W.

e. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

Sol       S $\frac{1}{\sqrt{T_J}}$ $\frac{1}{\sqrt{T_J}}$ Th)       S       S       N)       S	Test Conditions $V_{GS} = 0 \ V, \ I_D = 250 \ \mu A$ $I_D = 250 \ \mu A$ $V_{DS} = V_{GS}, \ I_D = 250 \ \mu A$ $V_{DS} = 0 \ V, \ V_{GS} = \pm 12 \ V$ $V_{DS} = 60 \ V, \ V_{GS} = 0 \ V$ $V_{DS} = 60 \ V, \ V_{GS} = 0 \ V$ $V_{DS} = 60 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C$ $V_{DS} = 5 \ V, \ V_{GS} = 4.5 \ V$ $V_{GS} = 10 \ V, \ I_D = 3.3 \ A$ $V_{GS} = 10 \ V, \ I_D = 4.5 \ A$ $V_{DS} = 10 \ V, \ I_D = 4.3 \ A$ $V_{DS} = 10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ $V_{DS} = 10 \ V, \ V_{GS} = 10 \ V, \ I_D = 6.3 \ A$ $V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 6.3 \ A$	Min. 60 1.5 25	Typ.           25           - 4.0           0.088           0.076           45           800           120           100           22           10           2.5	Max. 3.0 ± 100 1 10 	Unit V mV/°C V nA μA A Ω S pF nC
; /T_j n)/T_j tth) S S n) S n) on) S s s s s s d	$\begin{split} I_{D} &= 250 \ \mu A \\ \\ \hline V_{DS} &= V_{GS} \ , \ I_{D} &= 250 \ \mu A \\ \\ \hline V_{DS} &= 0 \ V, \ V_{GS} &= \pm 12 \ V \\ \\ \hline V_{DS} &= 60 \ V, \ V_{GS} &= 0 \ V \\ \\ \hline V_{DS} &= 60 \ V, \ V_{GS} &= 0 \ V, \ T_{J} &= 55 \ ^{\circ}C \\ \\ \hline V_{DS} &\geq 5 \ V, \ V_{GS} &= 4.5 \ V \\ \\ \hline V_{GS} &= 4.5 \ V, \ I_{D} &= 3.3 \ A \\ \\ \hline V_{GS} &= 10 \ V, \ I_{D} &= 4.3 \ A \\ \\ \hline V_{DS} &= 10 \ V, \ V_{GS} &= 0 \ V, \ f &= 1 \ MHz \\ \\ \hline V_{DS} &= 10 \ V, \ V_{GS} &= 10 \ V, \ I_{D} &= 6.3 \ A \\ \end{split}$	1.5	- 4.0 - 4.0 0.088 0.076 45 800 120 100 22 10	± 100 1 10	mV/°C V nA μA A Ω S
; /T_j n)/T_j tth) S S n) S n) on) S s s s s s d	$\begin{split} I_{D} &= 250 \ \mu A \\ \\ \hline V_{DS} &= V_{GS} \ , \ I_{D} &= 250 \ \mu A \\ \\ \hline V_{DS} &= 0 \ V, \ V_{GS} &= \pm 12 \ V \\ \\ \hline V_{DS} &= 60 \ V, \ V_{GS} &= 0 \ V \\ \\ \hline V_{DS} &= 60 \ V, \ V_{GS} &= 0 \ V, \ T_{J} &= 55 \ ^{\circ}C \\ \\ \hline V_{DS} &\geq 5 \ V, \ V_{GS} &= 4.5 \ V \\ \\ \hline V_{GS} &= 4.5 \ V, \ I_{D} &= 3.3 \ A \\ \\ \hline V_{GS} &= 10 \ V, \ I_{D} &= 4.3 \ A \\ \\ \hline V_{DS} &= 10 \ V, \ V_{GS} &= 0 \ V, \ f &= 1 \ MHz \\ \\ \hline V_{DS} &= 10 \ V, \ V_{GS} &= 10 \ V, \ I_{D} &= 6.3 \ A \\ \end{split}$	1.5	- 4.0 - 4.0 0.088 0.076 45 800 120 100 22 10	± 100 1 10	mV/°C V nA μA A Ω S
n)/TJ th) S S S n) pn) pn) s s s s s d	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{DS} = 0 \ V, V_{GS} = \pm 12 \ V$ $V_{DS} = 60 \ V, V_{GS} = 0 \ V$ $V_{DS} = 60 \ V, V_{GS} = 0 \ V, T_J = 55 \ ^{\circ}C$ $V_{DS} \ge 5 \ V, V_{GS} = 4.5 \ V$ $V_{GS} = 4.5 \ V, I_D = 3.3 \ A$ $V_{GS} = 10 \ V, I_D = 4.5 \ A$ $V_{DS} = 10 \ V, I_D = 4.3 \ A$ $V_{DS} = 10 \ V, V_{GS} = 0 \ V, f = 1 \ MHz$ $V_{DS} = 10 \ V, V_{GS} = 10 \ V, I_D = 6.3 \ A$		- 4.0 - 4.0 0.088 0.076 45 800 120 100 22 10	± 100 1 10	V nA μA A Ω S
s s s s s s s	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.088 0.076 45 800 120 100 22 10	± 100 1 10	V nA μA A Ω S
S S S n) on) S S S S S d	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.076 45 800 120 100 22 10	± 100 1 10	nA μA A Ω S
S n) on) s s s s s 1	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.076 45 800 120 100 22 10	1 10	μA A Ω S
n) on) s s s s s d	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.076 45 800 120 100 22 10	10 	A Ω S pF
n) on) s s s s s d	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ $V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.076 45 800 120 100 22 10	33	A Ω S pF
s s s	$V_{GS} = 4.5 \text{ V}, I_D = 3.3 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		0.076 45 800 120 100 22 10		Ω S pF
5 S S 5 d	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.5 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		0.076 45 800 120 100 22 10		pF
5 S S 5 d	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		45 800 120 100 22 10		pF
5 5 5 5	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		800 120 100 22 10		pF
s s 3	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		120 100 22 10		
s s 3	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		120 100 22 10		
s s t	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		100 22 10		
۔ د			22 10		nC
5 1			10		nC
5 1	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 6.3 A		-	15	nC
Ł	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 6.3 A		2.5		nC
					- nC
			1.7		
-+	f = 1 MHz		2.4		Ω
ר)			15	25	-
	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 1.5 \Omega$ $\text{I}_{D} \cong 6.7 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		10	15	
f)			35	55	
·			12	20	
ו)			10	15	ns
<u>,</u>	$V_{DD} = 10 \text{ V}, \text{ R}_1 = 1.5 \Omega$		12	20	-
f)	$I_D \cong 6.7 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$		25	40	
.,	· ·	-	10	15	
		1		1	
	T <sub>C</sub> = 25 °C			7.2	_
				25	A
	$I_{S} = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
		1	20	40	ns
			10	20	nC
	I <sub>F</sub> = 6.7 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-		-	- ns
		1	1 . ~		
	f) 1 	$T_{C} = 25 \text{ °C}$ $I_{S} = 6.7 \text{ A, } V_{GS} = 0 \text{ V}$	$T_{C} = 25 \text{ °C}$	$T_{C} = 25 \text{ °C}$ $I_{S} = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$ $20$ $10$	$T_{C} = 25 °C$

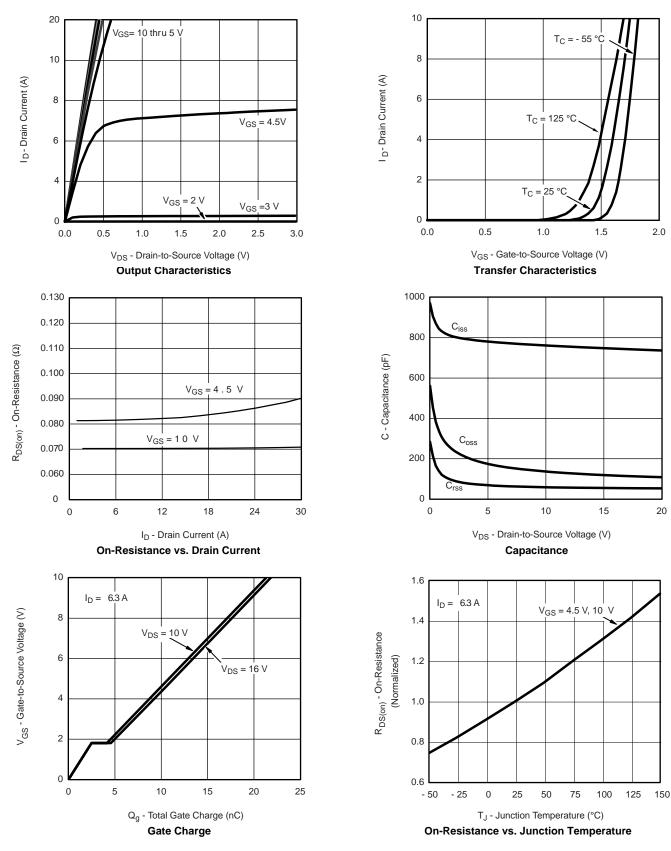
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

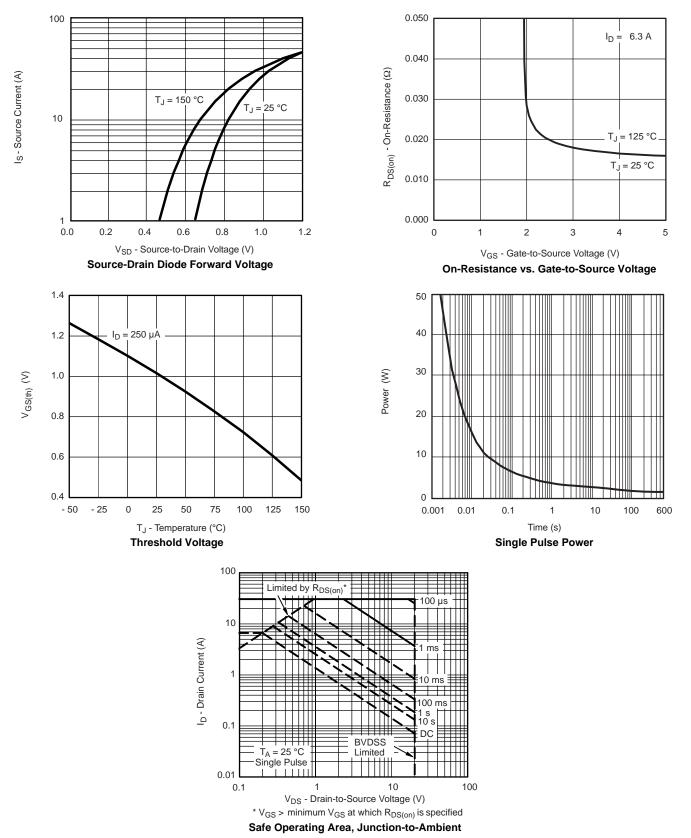
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

VBsemi Bsemi com

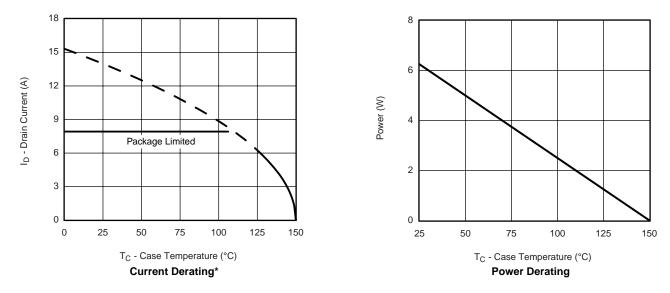






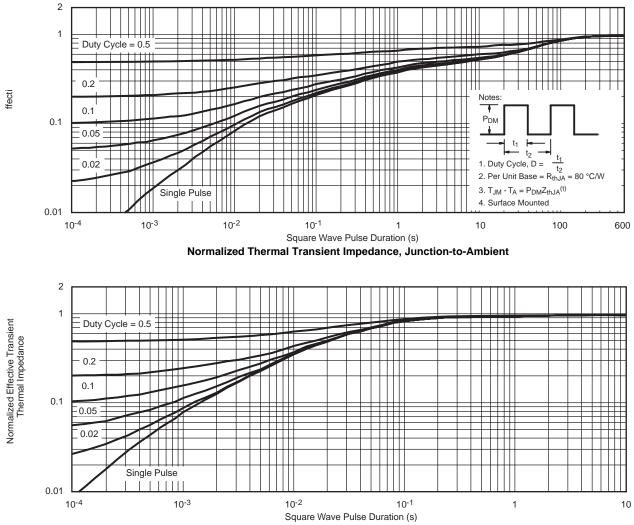






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



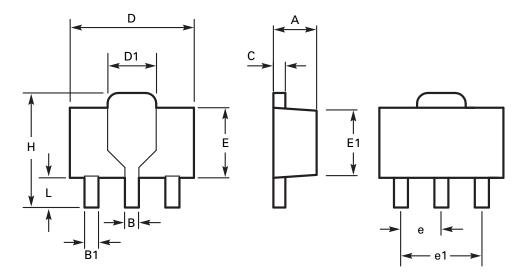


Normalized Thermal Transient Impedance, Junction-to-Foot

# AP2310GG-HF-VB



### Package outline - SOT89



DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
А	1.40	1.60	0.550	0.630	E	2.29	2.60	0.090	0.102
В	0.44	0.56	0.017	0.022	E1	2.13	2.29	0.084	0.090
B1	0.36	0.48	0.014	0.019	е	1.50 BSC		0.059 BSC	
С	0.35	0.44	0.014	0.017	e1	3.00 BSC		0.118 BSC	
D	4.40	4.60	0.173	0.181	Н	3.94	4.25	0.155	0.167
D1	1.62	1.83	0.064	0.072	L	0.89	1.20	0.035	0.047

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches



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